

Date Created : 2008/02/26  
Date Issued On : 2008/05/06  
PCN# : Q1080903

INFORMATION ONLY NOTIFICATION

This is to inform you that a minor change is being made to the following product(s). This notification is for your information only.

If you have any questions concerning this change, please contact:

Technical Contact:

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Implementation of change:

Expected 1st Device Shipment Date: 2008/05/14

Earliest Year/Work Week of Changed Product: 0820

Change Type Description: Information Only

Description of Change (From): The marketing outline dimension referenced in PCN#3073802-A for the TO-220 package heatsink thickness was incorrectly listed as 0.49mm (minimum) - 0.61mm (maximum).

Description of Change (To): The marketing outline dimension referenced in PCN#3073802-A for the TO-220 package heatsink thickness has been corrected to "A1" which denotes 0.51mm - 0.61mm for Single Gage and 1.14mm - 1.40mm for Dual Gage.

Reason for Change : The heatsink minimum dimension (A1) listed in the TO-220 package marketing outline drawing has been changed to align with JEDEC outline TO-220AB dimensional tolerance for this dimension. There is no change in actual package dimensions for the affected products list, referenced below.

Change To



TIP32	TIP32A	TIP32ATU
TIP32BTU	TIP32C	TIP32CTU
TIP41	TIP41A	TIP41B
TIP41BTU	TIP41C	TIP41CTU
TIP42	TIP42B	TIP42C
TIP42CTU	TIP47	TIP47TU
TIP48	TIP48TU	TIP49
TIP50	TIP50TU	